

Basic information	
2013/2905(DEA) DEA - Delegated acts procedure	Procedure completed - delegated act enters into force
<p>Exemption for lead in solders on printed circuit boards, termination coatings of electrical and electronic components and coatings of printed circuit boards, solders for connecting wires and cables, solders connecting transducers and sensors that are used durably at a temperature below –20°C</p> <p>Supplementing 2008/0240(COD)</p> <p>Subject</p> <p>3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)</p>	

Technical information	
Procedure reference	2013/2905(DEA)
Procedure type	DEA - Delegated acts procedure
Procedure subtype	Examination of delegated act
Amendments and repeals	Supplementing 2008/0240(COD)
Stage reached in procedure	Procedure completed - delegated act enters into force
Committee dossier	ENVI/7/14364